



池州华宇电子科技股份有限公司

CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD

焊线图纸 Bonding Diagram

客户代码  
Customer No.

线图号  
Drawing No.

页码 Page  
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产品名称  
Product Type

封装外型  
PKG Type

FCCSP32B(2.0×4.0×0.7-P0.40)

焊线种类  
Wire Type

焊线直径(μm)  
Wire Diameter

焊线根数  
NO. of wire

焊线总长(μm)  
Total wire length

最长线长(μm)  
Longest wire length

最短线长(μm)  
Shortest wire length

塑封料型号(绿色环保)  
Compound Type (Green)

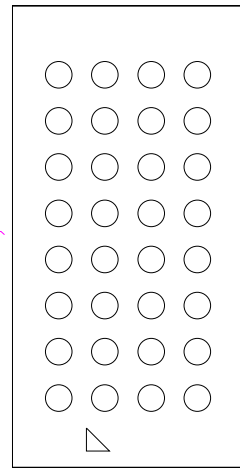
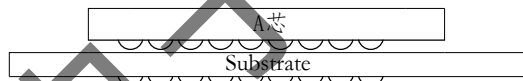
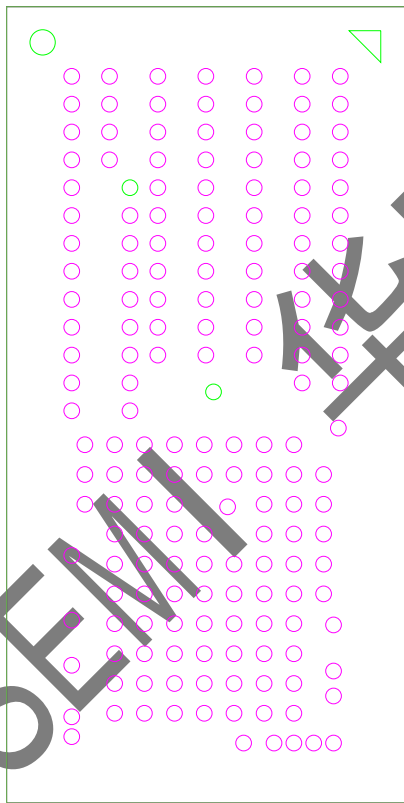
基板编码  
Substrate No.

客户图号

Customer drawing NO.

Overview

总览



Pin1 Corner

PIN 1

底部示意图